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3 Nature of conveyance: [x] Assignment [] Merger [l] Security Agreement [] Change of name [l] Other Execution Date: 1/7/99	Additional name(s) & address(es) attached ' [Yes [x] No
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DATE OF DEPOSIT: 1-14-59 Robitann Zene

BY SIGNATURE & DATE: PATENT

REEL: 9708 FRAME: 0739

Whereas, I.

Cyprian E. Uzoh County of Dutchess City of Hopewell Junction and State of New York

have invented certain improvements in

Process and Structure for an Interlock and High Performance Multilevel Structures for Chip Interconnects and Packaging Technologies

and have executed, respectively, a United States patent application therefor on

(1) = 1,7179

And whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504 (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor:

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns, and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

SIGNED AND SEALED

(l) at East Fishkill, NY

RECORDED: 01/14/1999

Cyprian F. Uzoh

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